

## CBR08C430JCGAC

**General Information** 

CBR-SMD RF COG, Ceramic, 43 pF, 5%, 500 VDC, COG, SMD, Fixed, RF, Ultra High Q, Low ESR, Class I, 0805



Series	CBR-SMD RF COG	
Style	SMD Chip	
Description	SMD, Fixed, RF, Ultra High Q, Low ESR, Class I	
Features	Ultra High Q, Low ESR, Class I	
RoHS	Yes	
Termination	Tin	
Marking	No	
AEC-Q200	No	
Typical Component Weight	12.03 mg	
Notes	Solder Wave or Solder Reflow.	
Shelf Life	78 Weeks	
MSL	1	

43 pF 5%

1000

Dimensions	
Chip Size	0805
L	2mm +/-0.2mm
W	1.25mm +/-0.2mm
т	0.85mm +/-0.1mm
В	0.5mm +/-0.2mm

′-0.2mm	Voltage DC	500 VDC
/-0.1mm	Dielectric Withstanding Voltage	750 VDC
-0.2mm	Temperature Range	-55/+125°C
	Temp. Coefficient	COG
	Dissipation Factor	0.1%
nm, Plastic Tape	Aging Rate	0% Loss/Decade Hour
	Insulation Resistance	10 GOhms

**Quality Factor** 

Specifications Capacitance

Tolerance

## **Packaging Specifications**

Packaging Packaging Quantity T&R, 180mi 4000

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